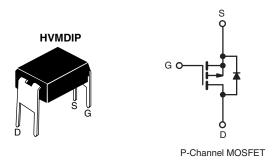


Vishay Siliconix

COMPLIANT

### **Power MOSFET**

PRODUCT SUMMARY			
V <sub>DS</sub> (V)	- 50		
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = - 10 V	0.50	
Q <sub>g</sub> (Max.) (nC)	11		
Q <sub>gs</sub> (nC)	3.8		
Q <sub>gd</sub> (nC)	4.1		
Configuration	Single		



#### **FEATURES**

- For Automatic Insertion
- · Compact, End Stackable
- · Fast Switching
- Low Drive Current
- Easy Paralleled
- Excellent Temperature Stability
- P-Channel Versatility
- Compliant to RoHS Directive 2002/95/EC

#### **DESCRIPTION**

The HVMDIP technology is the key to Vishay's advanced line of power MOSFET transistors. The efficient geometry and unique processing of the HVMDIP design achieves very low on-state resistance combined with high transconductance and extreme device ruggedness.

The p-channel HVMDIPs are designed for application which require the convenience of reverse polarity operation. They retain all of the features of the more common n-channel HVMDIPs such as voltage control, very fast switching, ease of paralleling, and excellent temperature stability.

P-channels HVMDIPs are intended for use in power stages where complementary symmetry with n-channel devices offers circuit simplification. They are also very useful in drive stages because of the circuit versatility offered by the reverse polarity connection. Applications include motor control, audio amplifiers, switched mode converters, control circuits and pulse amplifiers.

ORDERING INFORMATION		
Package	HVMDIP	
Lead (Pb)-free	IRFD9010PbF	
	SiHFD9010-E3	
SnPb	IRFD9010	
	SiHFD9010	

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	- 50	.,	
Gate-Source Voltage			V <sub>GS</sub>	± 20	v	
Continuous Drain Current	V <sub>GS</sub> at - 10 V	T <sub>C</sub> = 25 °C		- 1.1		
		T <sub>C</sub> = 100 °C	I <sub>D</sub>	- 0.68	А	
ulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	- 8.8		
Linear Derating Factor				0.01	W/°C	
Inductive Current, Clamped	L = 100 μH see fig. 14		I <sub>LM</sub>	- 8.8	^	
Inductive Current, Unclamped (Avalanche Current)	see fig. 15		Ι <sub>L</sub>	- 1.5	_ A	
Maximum Power Dissipation	T <sub>C</sub> = 25 °C		P <sub>D</sub>	1	W	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	1 00		
Soldering Recommendations (Peak Temperature)	for 10 s			300 <sup>d</sup>	°C	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD} = -25 \text{ V}$ , starting  $T_J = 25 \,^{\circ}\text{C}$ ,  $L = 52 \,^{\circ}\text{MH}$ ,  $R_0 = 25 \,^{\circ}\Omega$ ,  $I_{AS} = -2.0 \,^{\circ}\text{A}$  (see fig. 12).
- c.  $I_{SD} \le -4.0$  A,  $dI/dt \le 75$  A/ $\mu$ s,  $V_{DD} \le V_{DS}$ ,  $T_J \le 175$  °C.
- d. 1.6 mm from case.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply

# IRFD9010, SiHFD9010

# Vishay Siliconix



THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	120	°C/W	

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	- 50	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	Reference to 25 °C, I <sub>D</sub> = -1 mA		- 0.091	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$		- 2.0	-	- 4.0	٧
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>GS</sub> = ± 20 V		-	-	± 500	nA
Zana Oata Valta aa Dusin Ouwant		V <sub>DS</sub> = - 50 V, V <sub>GS</sub> = 0 V		-	-	- 250	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = - 40 V	/, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	- 1000	μA
On-State Drain Current	I <sub>D(on)</sub>	V <sub>GS</sub> = 10 V	$V_{DS} > I_{D(on)} \times R_{DS(on)} \max$ .	- 1.1	-	-	Α
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 10 V	I <sub>D</sub> = - 0.58 A <sup>b</sup>	-	0.35	0.50	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = - 20 V, I <sub>D</sub> = - 2.4 A		1.7	2.5	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 \text{ V},$ $V_{DS} = -25 \text{ V},$ f = 1.0  MHz,  see fig. 5			240	-	
Output Capacitance	C <sub>oss</sub>			=.	160	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>			=.	30	-	
Total Gate Charge	Qg			=.	7.2	11	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = - 10 V	$I_D = -4.7 \text{ A}, V_{DS} = 0.8 \text{ V}$ see fig. 6 and 13 <sup>b</sup>	=.	2.5	3.8	nC
Gate-Drain Charge	Q <sub>gd</sub>	]	See lig. 0 and 10		2.7	4.1	1
Turn-On Delay Time	t <sub>d(on)</sub>		'		6.1	9.2	- ns
Rise Time	t <sub>r</sub>	$V_{DD} = -25 \text{ V}, I_D = -4.7 \text{ A}$ $R_g = 24 \Omega, R_D = 5.6 \Omega,$ see fig. $10^b$		=.	47	71	
Turn-Off Delay Time	t <sub>d(off)</sub>			=.	13	20	
Fall Time	t <sub>f</sub>			=.	39	59	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.0	-	الم
Internal Source Inductance	L <sub>S</sub>			-	6.0	-	nH
<b>Drain-Source Body Diode Characteristic</b>	s						
Continuous Source-Drain Diode Current	Is	MOSFET symbol showing the		-	-	- 1.1	Α
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	- 8.8	
Body Diode Voltage	$V_{SD}$	$T_J = 25  ^{\circ}\text{C},  I_S = -0.7  \text{A},  V_{GS} = 0  \text{V}^{\text{b}}$		-	-	- 5.5	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = -4.7 A, dl/dt = 100 A/μs <sup>b</sup>		33	75	160	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			0.090	0.22	0.52	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by L <sub>S</sub> and L				L <sub>D</sub> )	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.



#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

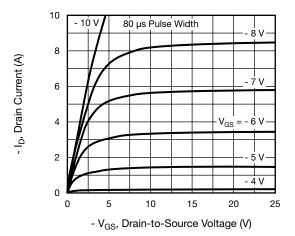


Fig. 1 - Typical Output Characteristics

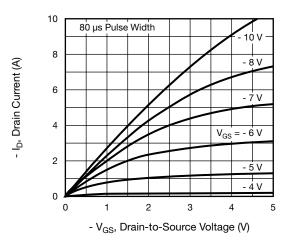


Fig. 2 - Typical Output Characteristics

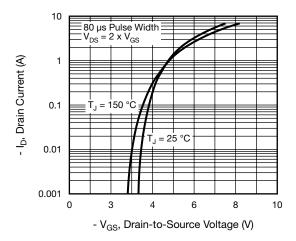


Fig. 3 - Typical Transfer Characteristics

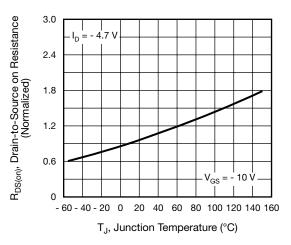


Fig. 4 - Normalized On-Resistance vs. Temperature

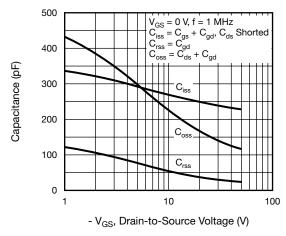


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

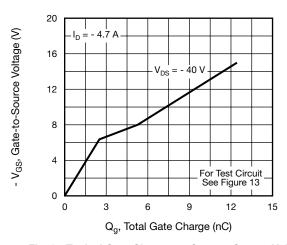


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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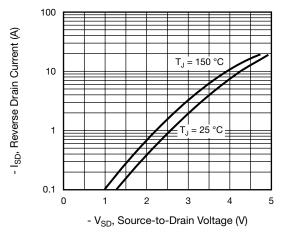


Fig. 7 - Typical Source-Drain Diode Forward Voltage

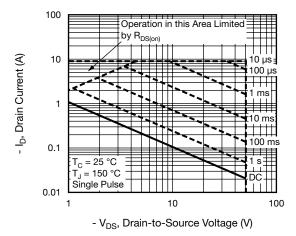


Fig. 8 - Maximum Safe Operating Area

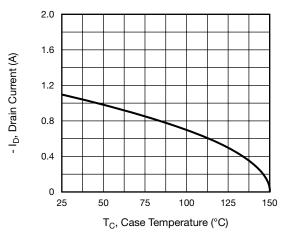


Fig. 9 - Maximum Drain Current vs. Case Temperature

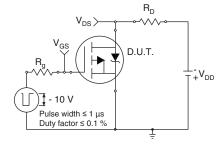


Fig. 10a - Switching Time Test Circuit

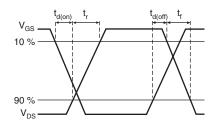


Fig. 10b - Switching Time Waveforms





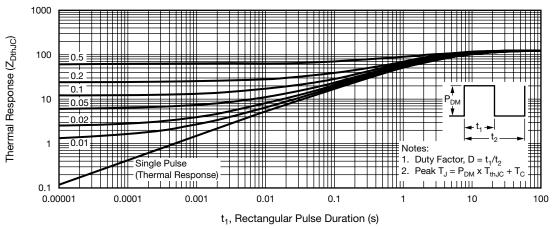


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

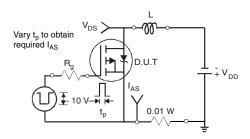


Fig. 12a - Unclamped Inductive Test Circuit

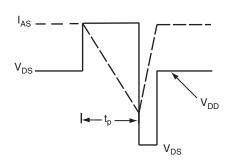


Fig. 12b - Unclamped Inductive Waveforms

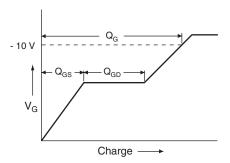


Fig. 13a - Basic Gate Charge Waveform

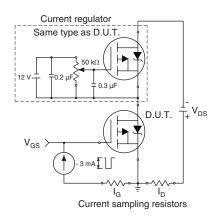
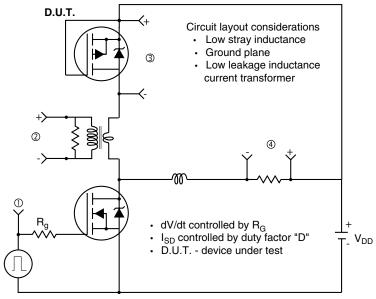


Fig. 13b - Gate Charge Test Circuit

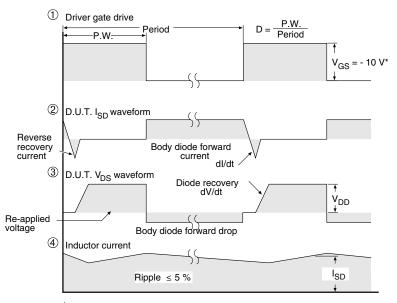
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#### Peak Diode Recovery dV/dt Test Circuit



• Compliment N-Channel of D.U.T. for driver



\* V<sub>GS</sub> = - 5 V for logic level and - 3 V drive devices

Fig. 14 - For P-Channel

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